## Dual D-Type Positive Edge-Triggered Flip-Flop

The MC74AC74/74ACT74 is a dual D-type flip-flop with Asynchronous Clear and Set inputs and complementary  $(Q,\overline{Q})$  outputs. Information at the input is transferred to the outputs on the positive edge of the clock pulse. Clock triggering occurs at a voltage level of the clock pulse and is not directly related to the transition time of the positive-going pulse. After the Clock Pulse input threshold voltage has been passed, the Data input is locked out and information present will not be transferred to the outputs until the next rising edge of the Clock Pulse input.

Asynchronous Inputs:

LOW input to  $\overline{S}_D$  (Set) sets Q to HIGH level LOW input to  $\overline{C}_D$  (Clear) sets Q to LOW level Clear and Set are independent of clock Simultaneous LOW on  $\overline{C}_D$  and  $\overline{S}_D$  makes both Q and  $\overline{Q}$  HIGH

## Features

- Outputs Source/Sink 24 mA
- 'ACT74 Has TTL Compatible Inputs
- These are Pb–Free Devices

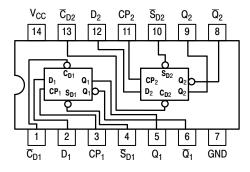
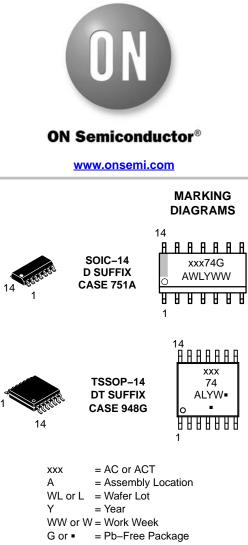


Figure 1. Pinout: 14–Lead Packages Conductors (Top View)

## **PIN ASSIGNMENT**

PIN	FUNCTION			
D <sub>1</sub> , D <sub>2</sub>	Data Inputs			
CP <sub>1</sub> , CP <sub>2</sub>	Clock Pulse Inputs			
$\overline{C}_{D1}, \overline{C}_{D2}$	Direct Clear Inputs			
$\overline{S}_{D1}, \overline{S}_{D2}$	Direct Set Inputs			
$\frac{Q_1,\overline{Q}_1,Q_2,}{\overline{Q}_2}$	Outputs			



(Note: Microdot may be in either location)

## **ORDERING INFORMATION**

See detailed ordering and shipping information in the package dimensions section on page 7 of this data sheet.

<sup>©</sup> Semiconductor Components Industries, LLC, 2015 January, 2015 – Rev. 8

## TRUTH TABLE (Each Half)

	Inp	Outputs			
<u></u> S <sub>D</sub>	$\overline{C}_{D}$	СР	D	Q	Q
L	Н	Х	Х	Н	L
Н	L	Х	Х	L	н
L	L	Х	Х	Н	н
Н	Н		Н	Н	L
Н	Н		L	L	н
Н	Н	L	Х	$Q_0$	$\overline{Q}_0$

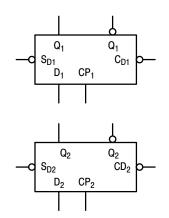
NOTE: H = HIGH Voltage Level

L = LOW Voltage Level

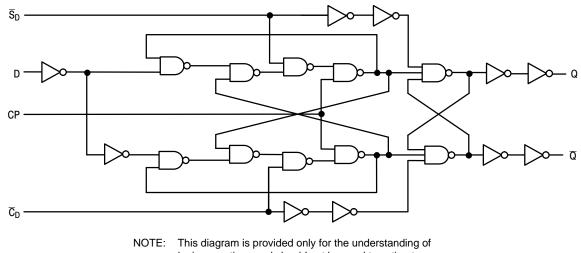
X = Immaterial;

 $\Box = LOW-to-HIGH Clock Transition$  $Q_0(\overline{Q}_0) = Previous Q(\overline{Q}) before LOW-to-HIGH$ 

Transition of Clock







logic operations and should not be used to estimate propagation delays.

Figure 3. Logic Diagram

#### MAXIMUM RATINGS

Symbol	Parameter		Value	Unit	
V <sub>CC</sub>	DC Supply Voltage		-0.5 to +7.0	V	
VI	DC Input Voltage		$-0.5 \leq V_I \leq V_{CC} + 0.5$	V	
V <sub>O</sub>	DC Output Voltage	(Note 1)	$-0.5 \leq V_O \leq V_{CC} + 0.5$	V	
I <sub>IK</sub>	DC Input Diode Current		±20	mA	
I <sub>OK</sub>	DC Output Diode Current		±50	mA	
I <sub>O</sub>	DC Output Sink/Source Current		±50	mA	
I <sub>CC</sub>	DC Supply Current per Output Pin		±50	mA	
I <sub>GND</sub>	DC Ground Current per Output Pin		±50		
T <sub>STG</sub>	Storage Temperature Range		-65 to +150	°C	
TL	Lead temperature, 1 mm from Case for 10 Sec	conds	260	°C	
TJ	Junction temperature under Bias		+ 150	°C	
$\theta_{JA}$	Thermal Resistance (Note 2)	SOIC TSSOP	125 170	°C/W	
P <sub>D</sub>	Power Dissipation in Still Air at 85°C	SOIC TSSOP	125 170	mW	
MSL	Moisture Sensitivity		Level 1		
F <sub>R</sub>	Flammability Rating O	xygen Index: 30% – 35%	UL 94 V-0 @ 0.125 in		
V <sub>ESD</sub>	, i i i i i i i i i i i i i i i i i i i	nan Body Model (Note 3) Machine Model (Note 4) ed Device Model (Note 5)	> 2000 > 200 > 1000	V	
I <sub>Latch-Up</sub>	Latch–Up Performance Above V <sub>CC</sub> and Belo	ow GND at 85°C (Note 6)	±100	mA	

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. I<sub>O</sub> absolute maximum rating must be observed.

The package thermal impedance is calculated in accordance with JESD51–7.
 Tested to EIA/JESD22–A114–A.

4. Tested to EIA/JESD22-A115-A.

5. Tested to JESD22-C101-A.

6. Tested to EIA/JESD78.

## **RECOMMENDED OPERATING CONDITIONS**

Symbol	Parameter			Тур	Max	Unit
N/		'AC	2.0	5.0	6.0	N/
V <sub>CC</sub>	Supply Voltage	′ACT	4.5	5.0	5.5	V
V <sub>in</sub> , V <sub>out</sub>	DC Input Voltage, Output Voltage (Ref. to GND)		0	-	V <sub>CC</sub>	V
			-	150	-	
t <sub>r</sub> , t <sub>f</sub>	r, t <sub>f</sub> / Input Rise and Fall Time (Note ) /AC Devices except Schmitt Inputs	V <sub>CC</sub> @ 4.5 V	-	40	-	ns/V
		V <sub>CC</sub> @ 5.5 V	-	25	-	
	Input Rise and Fall Time (Note)	V <sub>CC</sub> @ 4.5 V	-	10	-	<b>n</b> o///
t <sub>r</sub> , t <sub>f</sub>	ACT Devices except Schmitt Inputs	V <sub>CC</sub> @ 5.5 V	-	8.0	-	ns/V
TJ	Junction Temperature (PDIP)	•	_	-	140	°C
T <sub>A</sub>	Operating Ambient Temperature Range		-40	25	85	°C
I <sub>OH</sub>	Output Current – High		-	-	-24	mA
I <sub>OL</sub>	Output Current – Low		-	-	24	mA

Functional operation above the stresses listed in the Recommended Operating Ranges is not implied. Extended exposure to stresses beyond the Recommended Operating Ranges limits may affect device reliability. 1.  $V_{in}$  from 30% to 70%  $V_{CC}$ ; see individual Data Sheets for devices that differ from the typical input rise and fall times. 2.  $V_{in}$  from 0.8 V to 2.0 V; see individual Data Sheets for devices that differ from the typical input rise and fall times.

## **DC CHARACTERISTICS**

			74	AC	74AC		
Symbol	bl Parameter $V_{CC}$ $T_A = +25^{\circ}C$		T <sub>A</sub> = –40°C to +85°C	Unit	Conditions		
			Тур	Guar	anteed Limits		
V <sub>IH</sub>	Minimum High Level Input Voltage	3.0 4.5 5.5	1.5 2.25 2.75	2.1 3.15 3.85	2.1 3.15 3.85	v	$V_{OUT} = 0.1 V$ or $V_{CC} - 0.1 V$
V <sub>IL</sub>	Maximum Low Level Input Voltage	3.0 4.5 5.5	1.5 2.25 2.75	0.9 1.35 1.65	0.9 1.35 1.65	V	$V_{OUT} = 0.1 V$ or $V_{CC} - 0.1 V$
V <sub>OH</sub>	Minimum High Level Output Voltage	3.0 4.5 5.5	2.99 4.49 5.49	2.9 4.4 5.4	2.9 4.4 5.4	v	I <sub>OUT</sub> = -50 μA
		3.0 4.5 5.5	- - -	2.56 3.86 4.86	2.46 3.76 4.76	V	$V_{IN} = V_{IL} \text{ or } V_{IH}$ $-12 \text{ mA}$ $I_{OH} -24 \text{ mA}$ $-24 \text{ mA}$
V <sub>OL</sub>	Maximum Low Level Output Voltage	3.0 4.5 5.5	0.002 0.001 0.001	0.1 0.1 0.1	0.1 0.1 0.1	v	I <sub>OUT</sub> = 50 μA
		3.0 4.5 5.5	- -	0.36 0.36 0.36	0.44 0.44 0.44	V	$V_{IN} = V_{IL} \text{ or } V_{IH}$ 12 mA $I_{OL}$ 24 mA 24 mA
I <sub>IN</sub>	Maximum Input Leakage Current	5.5	-	±0.1	±1.0	μΑ	$V_{I} = V_{CC}, GND$
I <sub>OLD</sub>	†Minimum Dynamic	5.5	-	-	75	mA	V <sub>OLD</sub> = 1.65 V Max
I <sub>OHD</sub>	Output Current	5.5	-	-	-75	mA	V <sub>OHD</sub> = 3.85 V Min
I <sub>CC</sub>	Maximum Quiescent Supply Current	5.5	-	4.0	40	μΑ	$V_{IN} = V_{CC}$ or GND

\*All outputs loaded; thresholds on input associated with output under test. †Maximum test duration 2.0 ms, one output loaded at a time.

NOTE:  $I_{IN}$  and  $I_{CC}$  @ 3.0 V are guaranteed to be less than or equal to the respective limit @ 5.5 V V<sub>CC</sub>.

#### **AC CHARACTERISTICS**

				74AC		74	AC		
Symbol	Parameter					Unit	Fig. No.		
			Min	Тур	Max	Min	Max		
f <sub>max</sub>	Maximum Clock Frequency	3.3 5.0	100 140	125 160	-	95 125	-	MHz	3–3
t <sub>PLH</sub>	Propagation Delay $\overline{C}_{Dn}$ or $\overline{S}_{Dn}$ to $Q_n$ or $\overline{Q}_n$	3.3 5.0	5.0 3.5	8.0 6.0	12.5 9.0	4.0 3.0	13.0 10.0	ns	3–6
t <sub>PHL</sub>	Propagation Delay $\overline{C}_{Dn}$ or $\overline{S}_{Dn}$ to $Q_n$ or $\overline{Q}_n$	3.3 5.0	4.0 3.0	10.5 8.0	12.0 9.5	3.5 2.5	13.5 10.5	ns	3–6
t <sub>PLH</sub>	Propagation Delay $C_{Pn}$ to $Q_n$ or $\overline{Q}_n$	3.3 5.0	4.5 3.5	8.0 6.0	13.5 10.0	4.0 3.0	16.0 10.5	ns	3–6
t <sub>PHL</sub>	Propagation Delay $C_{Pn}$ to $Q_n$ or $\overline{Q}_n$	3.3 5.0	3.5 2.5	8.0 6.0	14.0 10.0	3.5 2.5	14.5 10.5	ns	3–6

\*Voltage Range 3.3 V is 3.3 V  $\pm 0.3$  V. Voltage Range 5.0 V is 5.0 V  $\pm 0.5$  V.

## AC OPERATING REQUIREMENTS

				74AC	74AC				
Symbol	Parameter	V <sub>CC</sub> * (V)	T <sub>A</sub> = +25°C C <sub>L</sub> = 50 pF				to +85°C	Unit	Fig. No.
			Тур	Guaranteed Minimum					
t <sub>s</sub>	Set-up Time, HIGH or LOW $D_n$ to $CP_n$	3.3 5.0	1.5 1.0	4.0 3.0	4.5 3.0	ns	3–9		
t <sub>h</sub>	Hold Time, HIGH or LOW $D_n$ to $CP_n$	3.3 5.0	-2.0 -1.5	0.5 0.5	0.5 0.5	ns	3–9		
t <sub>w</sub>	C <sub>Pn</sub> or $\overline{C}_{Dn}$ or $\overline{S}_{Dn}$ Pulse Width	3.3 5.0	3.0 2.5	5.5 4.5	7.0 5.0	ns	3–6		
t <sub>rec</sub>	Recovery Time $\overline{C}_{Dn}$ or $\overline{S}_{Dn}$ to CP	3.3 5.0	-2.5 -2.0	0 0	0 0	ns	3–9		

\*Voltage Range 3.3 V is 3.3 V  $\pm 0.3$  V. Voltage Range 5.0 V is 5.0 V  $\pm 0.5$  V.

## **DC CHARACTERISTICS**

			744	СТ	74ACT		
Symbol	Parameter	V <sub>CC</sub> (V)	T <sub>A</sub> = +25°C		T <sub>A</sub> = –40°C to +85°C	Unit	Conditions
			Тур	Guar	anteed Limits		
V <sub>IH</sub>	Minimum High Level Input Voltage	4.5 5.5	1.5 1.5	2.0 2.0	2.0 2.0	V	$V_{OUT} = 0.1 V$ or $V_{CC} - 0.1 V$
V <sub>IL</sub>	Maximum Low Level Input Voltage	4.5 5.5	1.5 1.5	0.8 0.8	0.8 0.8	V	$V_{OUT} = 0.1 V$ or $V_{CC} - 0.1 V$
V <sub>OH</sub>	Minimum High Level Output Voltage	4.5 5.5	4.49 5.49	4.4 5.4	4.4 5.4	V	I <sub>OUT</sub> = -50 μA
		4.5 5.5		3.86 4.86	3.76 4.76	V	$V_{IN} = V_{IL} \text{ or } V_{IH}$ -24 mA $I_{OH}$ -24 mA
V <sub>OL</sub>	Maximum Low Level Output Voltage	4.5 5.5	0.001 0.001	0.1 0.1	0.1 0.1	V	I <sub>OUT</sub> = 50 μA
		4.5 5.5		0.36 0.36	0.44 0.44	V	$V_{IN} = V_{IL} \text{ or } V_{IH}$ 24 mA $I_{OL}$ 24 mA
I <sub>IN</sub>	Maximum Input Leakage Current	5.5	-	±0.1	±1.0	μΑ	$V_{I} = V_{CC}, GND$
$\Delta I_{CCT}$	Additional Max. I <sub>CC</sub> /Input	5.5	0.6	-	1.5	mA	$V_{I} = V_{CC} - 2.1 V$
I <sub>OLD</sub>	†Minimum Dynamic	5.5	-	-	75	mA	V <sub>OLD</sub> = 1.65 V Max
I <sub>OHD</sub>	Output Current	5.5	-	-	-75	mA	V <sub>OHD</sub> = 3.85 V Min
I <sub>CC</sub>	Maximum Quiescent Supply Current	5.5	_	4.0	40	μΑ	$V_{IN} = V_{CC}$ or GND

\*All outputs loaded; thresholds on input associated with output under test. †Maximum test duration 2.0 ms, one output loaded at a time.

## AC CHARACTERISTICS

				74ACT		74A	СТ		
Symbol	Parameter	$V_{CC}^{*}$ $T_{A} = +25^{\circ}C$ (V) $C_{L} = 50 \text{ pF}$				Unit	Fig. No.		
			Min	Тур	Max	Min	Max		
f <sub>max</sub>	Maximum Clock Frequency	5.0	145	210	-	125	-	MHz	3–3
t <sub>PLH</sub>	Propagation Delay $\overline{C}_{Dn}$ or $\overline{S}_{Dn}$ to $Q_n$ or $\overline{Q}_n$	5.0	3.0	5.5	9.5	2.5	10.5	ns	3–6
t <sub>PHL</sub>	Propagation Delay $\overline{C}_{Dn}$ or $\overline{S}_{Dn}$ to $Q_n$ or $\overline{Q}_n$	5.0	3.0	6.0	10.0	3.0	11.5	ns	3–6
t <sub>PLH</sub>	Propagation Delay $C_{Pn}$ to $Q_n$ or $\overline{Q}_n$	5.0	4.0	7.5	11.0	4.0	13.0	ns	3–6
t <sub>PHL</sub>	Propagation Delay $C_{Pn}$ to $Q_n$ or $\overline{Q}_n$	5.0	3.5	6.0	10.0	3.0	11.5	ns	3–6

\*Voltage Range 5.0 V is 5.0 V  $\pm$ 0.5 V.

## AC OPERATING REQUIREMENTS

				74ACT	74ACT						
Symbol	Parameter	V <sub>CC</sub> * (V)	T <sub>A</sub> = +25°C C <sub>L</sub> = 50 pF						T <sub>A</sub> = −40°C to +85°C C <sub>L</sub> = 50 pF	Unit	Fig. No.
			Тур	Guarantee	d Minimum						
t <sub>s</sub>	Set-up Time, HIGH or LOW D <sub>n</sub> to CP <sub>n</sub>	5.0	1.0	3.0	3.5	ns	3–9				
t <sub>h</sub>	Hold Time, HIGH or LOW D <sub>n</sub> to CP <sub>n</sub>	5.0	-0.5	1.0	1.0	ns	3–9				
t <sub>w</sub>	C <sub>Pn</sub> or C <sub>Dn</sub> or S <sub>Dn</sub> Pulse Width	5.0	3.0	5.0	6.0	ns	3–6				
t <sub>rec</sub>	Recovery Time $\overline{C}_{Dn}$ or $\overline{S}_{Dn}$ to CP	5.0	-2.5	0	0	ns	3–9				

\*Voltage Range 5.0 V is 5.0 V  $\pm$ 0.5 V.

## CAPACITANCE

Symbol	Parameter	Value Typ	Unit	Test Conditions
C <sub>IN</sub>	Input Capacitance	4.5	pF	$V_{CC} = 5.0 V$
C <sub>PD</sub>	Power Dissipation Capacitance	35	pF	$V_{CC} = 5.0 V$

## ORDERING INFORMATION

Device	Package	Shipping <sup>†</sup>
MC74AC74DG	SOIC-14 (Pb-Free)	55 Units/Rail
MC74AC74DR2G	SOIC-14 (Pb-Free)	2500/Tape & Reel
MC74AC74DTR2G	TSSOP-14 (Pb-Free)	2500/Tape & Reel
MC74ACT74DG	SOIC-14 (Pb-Free)	55 Units/Rail
MC74ACT74DR2G	SOIC-14 (Pb-Free)	2500/Tape & Reel
MC74ACT74DTR2G	TSSOP-14 (Pb-Free)	2500/Tape & Reel

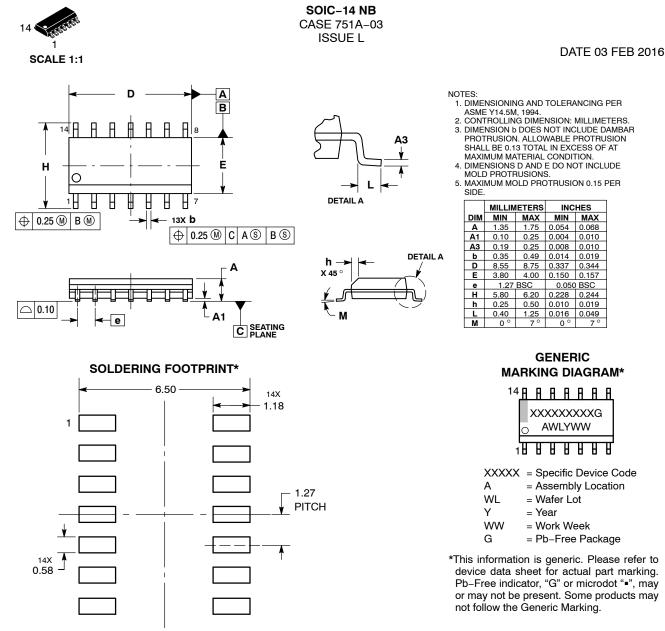
+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

# DUSEM

0.068

0.019

0.344



DIMENSIONS: MILLIMETERS

\*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

## **STYLES ON PAGE 2**

Electronic versions are uncontrolled except when accessed directly from the Document Repository. DOCUMENT NUMBER: 98ASB42565B Printed versions are uncontrolled except when stamped "CONTROLLED COPY" in red. **DESCRIPTION:** SOIC-14 NB PAGE 1 OF 2 onsemi and ONSEMI are trademarks of Semiconductor Components Industries, LLC dba onsemi or its subsidiaries in the United States and/or other countries. onsemi reserves the right to make changes without further notice to any products herein. onsemi makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does onsemi assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. onsemi does not convey any license under its patent rights nor the rights of others.

#### SOIC-14 CASE 751A-03 ISSUE L

## DATE 03 FEB 2016

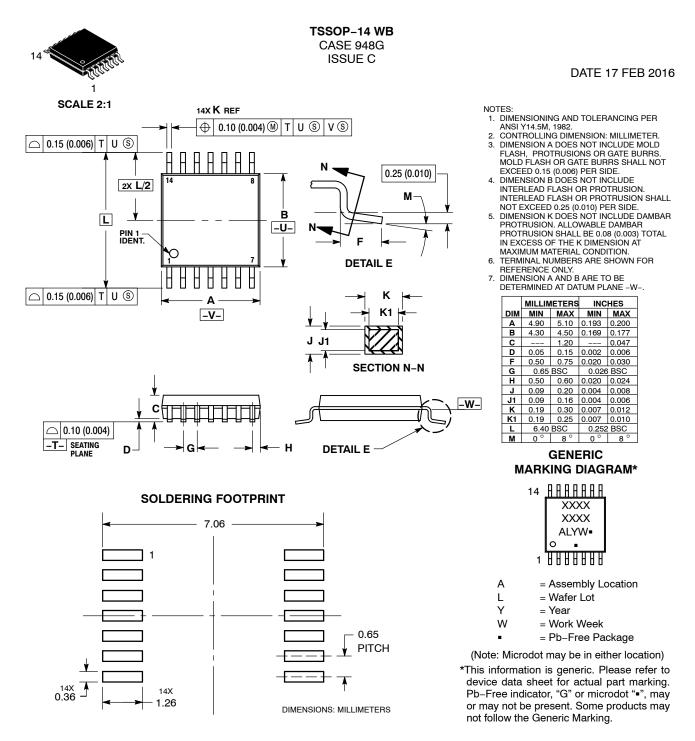
STYLE 1: PIN 1. COMMON CATHODE 2. ANODE/CATHODE 3. ANODE/CATHODE 4. NO CONNECTION 5. ANODE/CATHODE 6. NO CONNECTION 7. ANODE/CATHODE 8. ANODE/CATHODE 9. ANODE/CATHODE 10. NO CONNECTION 11. ANODE/CATHODE 12. ANODE/CATHODE 13. NO CONNECTION 14. COMMON ANODE	STYLE 2: CANCELLED	STYLE 3: PIN 1. NO CONNECTION 2. ANODE 3. ANODE 4. NO CONNECTION 5. ANODE 6. NO CONNECTION 7. ANODE 8. ANODE 9. ANODE 10. NO CONNECTION 11. ANODE 12. ANODE 13. NO CONNECTION 14. COMMON CATHODE	STYLE 4: PIN 1. NO CONNECTION 2. CATHODE 3. CATHODE 4. NO CONNECTION 5. CATHODE 6. NO CONNECTION 7. CATHODE 9. CATHODE 10. NO CONNECTION 11. CATHODE 12. CATHODE 13. NO CONNECTION 14. COMMON ANODE
STYLE 5: PIN 1. COMMON CATHODE 2. ANODE/CATHODE 3. ANODE/CATHODE 4. ANODE/CATHODE 5. ANODE/CATHODE 6. NO CONNECTION 7. COMMON ANODE 8. COMMON CATHODE 9. ANODE/CATHODE 10. ANODE/CATHODE 11. ANODE/CATHODE 12. ANODE/CATHODE 13. NO CONNECTION 14. COMMON ANODE	STYLE 6: PIN 1. CATHODE 2. CATHODE 3. CATHODE 4. CATHODE 5. CATHODE 6. CATHODE 7. CATHODE 8. ANODE 9. ANODE 10. ANODE 11. ANODE 12. ANODE 13. ANODE 14. ANODE	STYLE 7: PIN 1. ANODE/CATHODE 2. COMMON ANODE 3. COMMON CATHODE 4. ANODE/CATHODE 5. ANODE/CATHODE 7. ANODE/CATHODE 8. ANODE/CATHODE 10. ANODE/CATHODE 11. COMMON CATHODE 12. COMMON ANODE 13. ANODE/CATHODE 14. ANODE/CATHODE	STYLE 8: PIN 1. COMMON CATHODE 2. ANODE/CATHODE 3. ANODE/CATHODE 4. NO CONNECTION 5. ANODE/CATHODE 6. ANODE/CATHODE 7. COMMON ANODE 8. COMMON ANODE 9. ANODE/CATHODE 10. ANODE/CATHODE 11. NO CONNECTION 12. ANODE/CATHODE 13. ANODE/CATHODE 14. COMMON CATHODE

DOCUMENT NUMBER:	98ASB42565B	Electronic versions are uncontrolled except when accessed directly from the Document Repository. Printed versions are uncontrolled except when stamped "CONTROLLED COPY" in red.		
DESCRIPTION:	SOIC-14 NB		PAGE 2 OF 2	

onsemi and ONSEMI are trademarks of Semiconductor Components Industries, LLC dba onsemi or its subsidiaries in the United States and/or other countries. onsemi reserves the right to make changes without further notice to any products herein. onsemi makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does onsemi assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. onsemi does not convey any license under its patent rights nor the rights of others.

## MECHANICAL CASE OUTLINE PACKAGE DIMENSIONS

# onsemí



DOCUMENT NUMBER:	98ASH70246A	Electronic versions are uncontrolled except when accessed directly from the Document Repository. Printed versions are uncontrolled except when stamped "CONTROLLED COPY" in red.			
DESCRIPTION:	TSSOP-14 WB		PAGE 1 OF 1		
onsemi and ONSEMi. are trademarks of Semiconductor Components Industries, LLC dba onsemi or its subsidiaries in the United States and/or other countries. onsemi reserves the right to make changes without further notice to any products herein. onsemi makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does onsemi assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation					

special, consequential or incidental damages. onsemi does not convey any license under its patent rights nor the rights of others.

onsemi, ONSEMI, and other names, marks, and brands are registered and/or common law trademarks of Semiconductor Components Industries, LLC dba "onsemi" or its affiliates and/or subsidiaries in the United States and/or other countries. onsemi owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of onsemi's product/patent coverage may be accessed at <u>www.onsemi.com/site/pdf/Patent\_Marking.pdf</u>. onsemi reserves the right to make changes at any time to any products or information herein, without notice. The information herein is provided "as-is" and onsemi makes no warranty, representation or guarantee regarding the accuracy of the information, product features, availability, functionality, or suitability of its products for any particular purpose, nor does onsemi assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or indental damages. Buyer is responsible for its products and applications using onsemi products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by onsemi. "Typical" parameters which may be provided in onsemi data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. onsemi does not convey any license under any of its intellectual property rights nor the rights of others. onsemi products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification. Buyer shall indemnify and hold onsemi and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs,

#### ADDITIONAL INFORMATION

TECHNICAL PUBLICATIONS:

Technical Library: www.onsemi.com/design/resources/technical-documentation onsemi Website: www.onsemi.com

ONLINE SUPPORT: <u>www.onsemi.com/support</u> For additional information, please contact your local Sales Representative at <u>www.onsemi.com/support/sales</u>